

N-Channel 20-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|--------------------------------------|--------------------|--|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) | | |
| 20 | 0.0035 at $V_{GS} = 4.5 \text{ V}$ | 25 | | |
| | 0.0047 at V _{GS} = 2.5 V | 20 | | |

SO-8 D D D D

Top View

Ordering Information: Si4864DY-T1-E3 (Lead (Pb)-free) Si4864DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

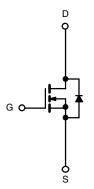
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFETs: 2.5 V Rated
- Low 3.5 m Ω R_{DS(on)}
- PWM (Q_{gd} and R_g) Optimized



APPLICATIONS

• Low-Side MOSFET in Synchronous Buck DC/DC Converters in Servers and Routers



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS | T _A = 25 °C, unle | ss otherwise n | oted | | |
|---|------------------------------|-----------------------------------|--------|--------------|------|
| Parameter | | Symbol | 10 s | Steady State | Unit |
| Drain-Source Voltage | | V _{DS} | 20 | | V |
| Gate-Source Voltage | | V _{GS} | ± 8 | | V |
| O-ations David O-and (T., 150.00) | T _A = 25 °C | - I _D | 25 | 17 | |
| Continuous Drain Current (T _J = 150 °C) ^a | T _A = 70 °C | | 20 | 13 | |
| Pulsed Drain Current (10 μs Pulse Width) | | I _{DM} | 60 | | Α |
| Continuous Source Current (Diode Conduction) ^a | | I _S | 2.9 | 1.3 | |
| | T _A = 25 °C | P _D | 3.5 | 1.6 | W |
| Maximum Power Dissipation ^a | T _A = 70 °C |] 'D | 2.2 | 1 | VV |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 t | o 150 | °C |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Manipular Landian La Anglianda | t ≤ 10 s | R _{thJA} | 29 | 35 | |
| Maximum Junction-to-Ambient ^a | Steady State | ' 'thJA | 67 | 80 | °C/W |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 13 | 16 | |

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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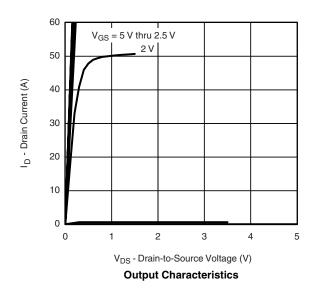
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|---------------------|--|------|--------|--------|------|--|
| Static | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 0.6 | | 2 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$ | | | ± 100 | nA | |
| Zava Cata Valtaga Drain Current | 1 | V _{DS} = 20 V, V _{GS} = 0 V | | | 1 | μΑ | |
| Zero Gate Voltage Drain Current | IDSS | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$ | | | 5 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ | 30 | | | Α | |
| Drain-Source On-State Resistance ^a | В | $V_{GS} = 4.5 \text{ V}, I_D = 25 \text{ A}$ | | 0.0028 | 0.0035 | Ω | |
| | R _{DS(on)} | $V_{GS} = 2.5 \text{ V}, I_D = 20 \text{ A}$ | | 0.0038 | 0.0047 | | |
| Forward Transconductance ^a | 9 _{fs} | $V_{DS} = 6 \text{ V}, I_{D} = 25 \text{ A}$ | | 70 | | S | |
| Diode Forward Voltage ^a | V_{SD} | $I_S = 2.9 \text{ A}, V_{GS} = 0 \text{ V}$ | | 0.70 | 1.1 | ٧ | |
| Dynamic ^b | | | | • | 1 | | |
| Total Gate Charge | Qg | | | 47 | 70 | | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 25 \text{ A}$ | | 10 | | nC | |
| Gate-Drain Charge | Q_{gd} | | | 13.4 | | | |
| Gate Resistance | R_g | | 0.5 | 1.5 | 2.6 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 40 | 60 | | |
| Rise Time | t _r | V_{DD} = 10 V, R_L = 10 Ω | | 44 | 65 | | |
| Turn-Off Delay Time | t _{d(off)} | $I_D\cong$ 1 A, V_{GEN} = 4.5 V, R_g = 6 Ω | | 150 | 240 | ns | |
| Fall Time | t _f | | | 72 | 110 | | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = 2.9 A, dI/dt = 100 A/μs | | 57 | 80 | | |

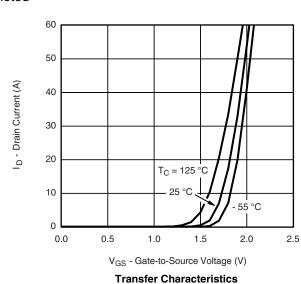
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

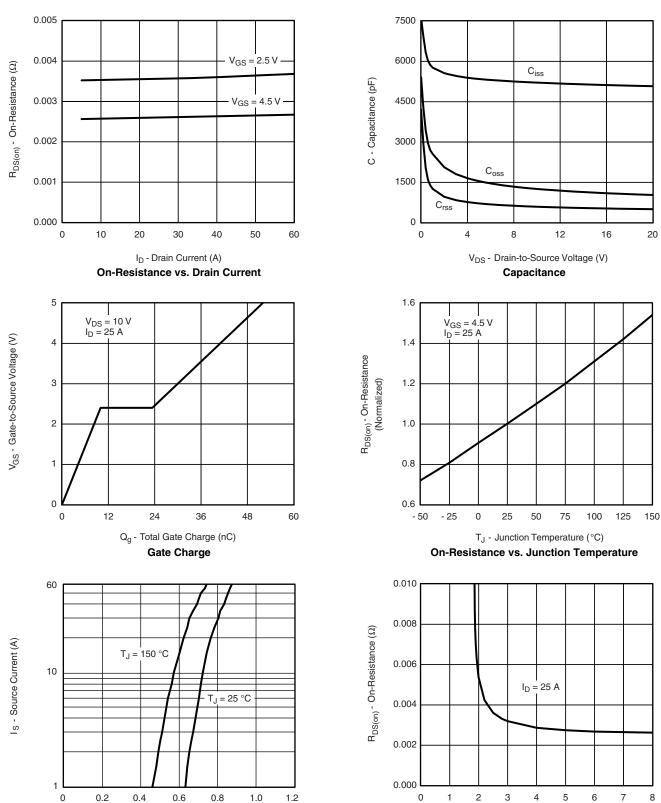








TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



0

0.2

0.4

0.6

V_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

0.8

1.0

1.2

0

2

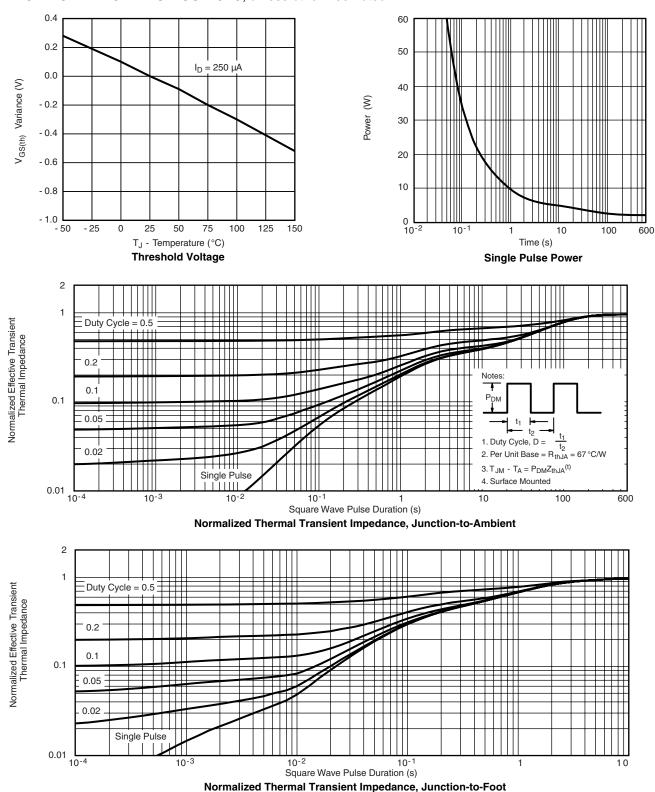
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V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage

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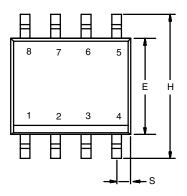
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







| | MILLIMETERS INCHES | | | HES | | |
|------------------------------|--------------------|------|--------|-------|--|--|
| DIM | Min | Max | Min | Max | | |
| Α | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| Е | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 | BSC | 0.050 |) BSC | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| FCN: C-06527-Bey 11-Sen-06 | | | | | | |

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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Revision: 13-Jun-16 1 Document Number: 91000